

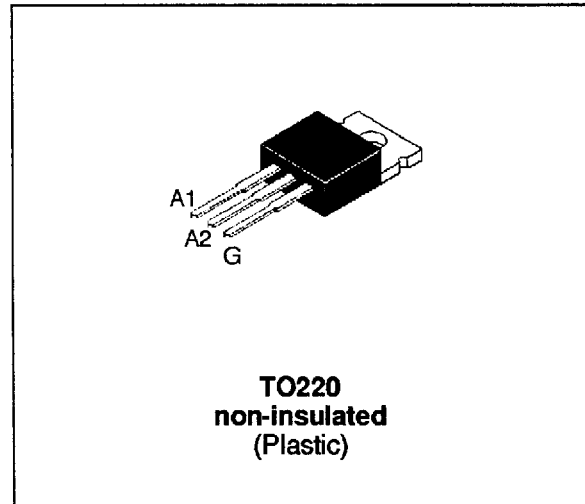
## STANDARD TRIACS

### FEATURES

- $I_{T(RMS)} = 16A$
- $V_{DRM} = 400V$  to  $800V$
- High surge current capability

### DESCRIPTION

The T16xxxH series of triacs uses a high performance MESA GLASS technology. These parts are intended for general purpose switching and phase control applications.



### ABSOLUTE RATINGS (limiting values)

Symbol	Parameter		Value	Unit
$I_{T(RMS)}$	RMS on-state current (360° conduction angle)	$T_c = 90^\circ C$	16	A
$I_{TSM}$	Non repetitive surge peak on-state current ( $T_j$ initial = $25^\circ C$ )	$t_p = 8.3$ ms	157	A
		$t_p = 10$ ms	150	
$I^2t$	$I^2t$ Value for fusing	$t_p = 10$ ms	112	$A^2s$
$di/dt$	Critical rate of rise of on-state current $I_G = 500$ mA $di_G/dt = 1$ A/ $\mu s$ .	Repetitive F = 50 Hz	10	A/ $\mu s$
		Non Repetitive	50	
$T_{stg}$ $T_j$	Storage and operating junction temperature range		- 40, + 150 - 40, + 125	$^\circ C$
TI	Maximum lead temperature for soldering during 10s at 4.5mm from case		260	$^\circ C$

Symbol	Parameter	Voltage				Unit
		D	M	S	N	
$V_{DRM}$ $V_{RRM}$	Repetitive peak off-state voltage $T_j = 125^\circ C$	400	600	700	800	V

# T16xxxH

## THERMAL RESISTANCES

Symbol	Parameter	Value	Unit
Rth(j-a)	Junction to ambient	60	°C/W
Rth(j-c)	Junction to case for D.C	2.4	°C/W
Rth(j-c)	Junction to case for A.C 360° conduction angle (F=50Hz)	1.8	°C/W

## GATE CHARACTERISTICS (maximum values)

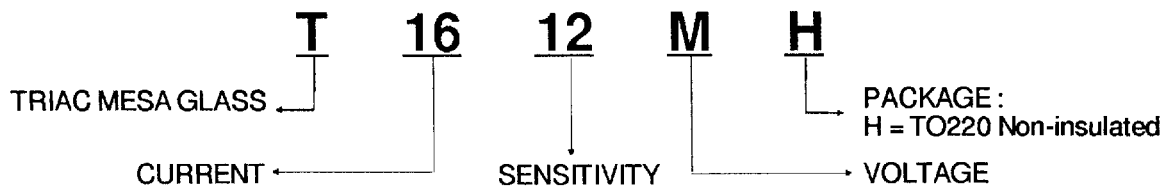
$P_G (AV) = 1 W$   $P_{GM} = 10 W$  ( $t_p = 20 \mu s$ )  $I_{GM} = 4 A$  ( $t_p = 20 \mu s$ )

## ELECTRICAL CHARACTERISTICS

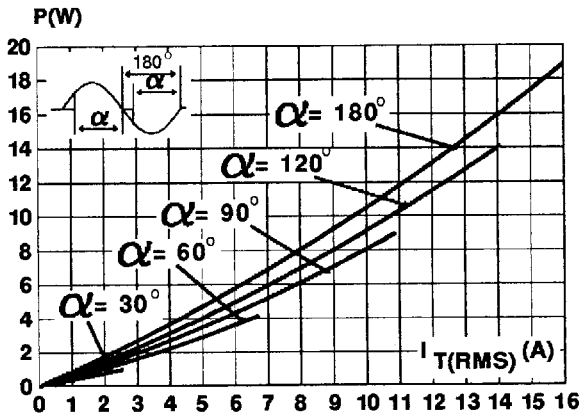
Symbol	Test Conditions		Quadrant		Sensitivity		Unit
					12	13	
$I_{GT}$	$V_D = 12V$ (DC) $R_L = 33\Omega$	$T_j = 25^\circ C$	I-II-III	MAX	50	50	mA
			IV	MAX	50	75	
$V_{GT}$	$V_D = 12V$ (DC) $R_L = 33\Omega$	$T_j = 25^\circ C$	I-II-III-IV	MAX	1.5		V
$V_{GD}$	$V_D = V_{DRM}$ $R_L = 3.3k\Omega$	$T_j = 125^\circ C$	I-II-III-IV	MIN	0.2		V
$t_{gt}$	$V_D = V_{DRM}$ $I_G = 500mA$ $I_T = 22.5A$ $di_G/dt = 3A/\mu s$	$T_j = 25^\circ C$	I-II-III-IV	TYP	2		$\mu s$
$I_H^*$	$I_T = 250 mA$ Gate open	$T_j = 25^\circ C$		MAX	50	75	mA
$I_L$	$I_G = 1.2 I_{GT}$	$T_j = 25^\circ C$	I-III-IV	TYP	50	75	mA
			II	TYP	100	150	
$V_{TM}^*$	$I_{TM} = 22.5A$ $t_p = 380\mu s$	$T_j = 25^\circ C$		MAX	1.5		V
$I_{DRM}$ $I_{RRM}$	$V_D = V_{DRM}$ $V_R = V_{RRM}$	$T_j = 25^\circ C$		MAX	10		$\mu A$
		$T_j = 110^\circ C$		MAX	2.5		mA
$dV/dt^*$	$V_D = 67\% V_{DRM}$ Gate open	$T_j = 110^\circ C$		MIN	500		V/ $\mu s$
$(dV/dt)_c^*$	$(di/dt)_c = 7 A/ms$	$T_j = 110^\circ C$		MIN	5	10	V/ $\mu s$

\* For either polarity of electrode  $A_2$  voltage with reference to electrode  $A_1$

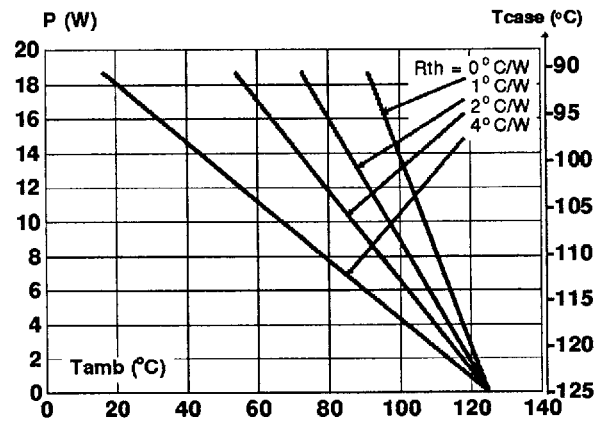
## ORDERING INFORMATION



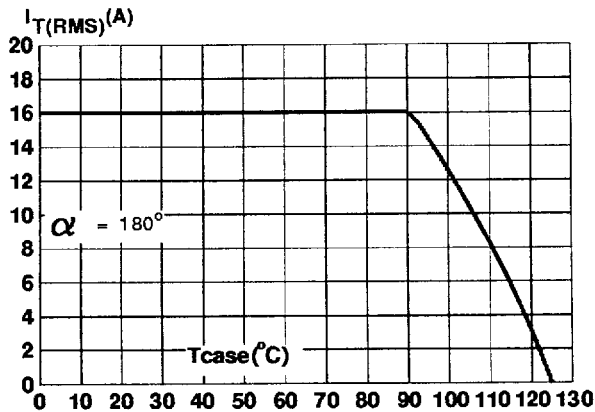
**Fig.1 :** Maximum RMS power dissipation versus RMS on-state current.



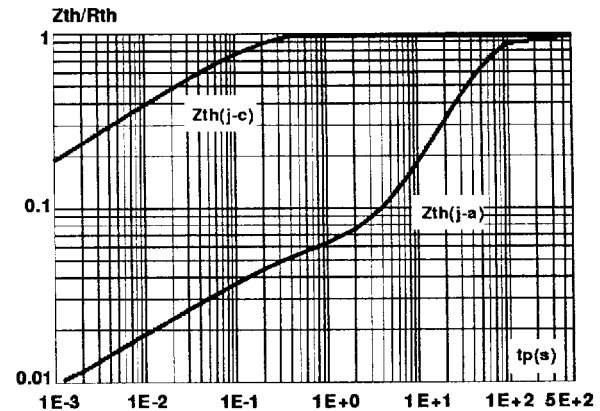
**Fig.2 :** Correlation between maximum RMS power dissipation and maximum allowable temperature (Tamb and Tcase) for different thermal resistances heatsink + contact.



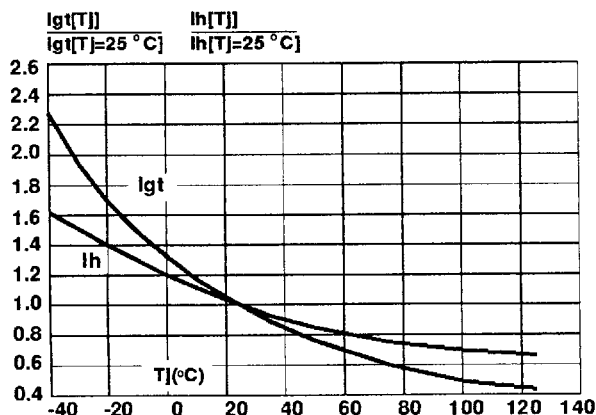
**Fig.3 :** RMS on-state current versus case temperature.



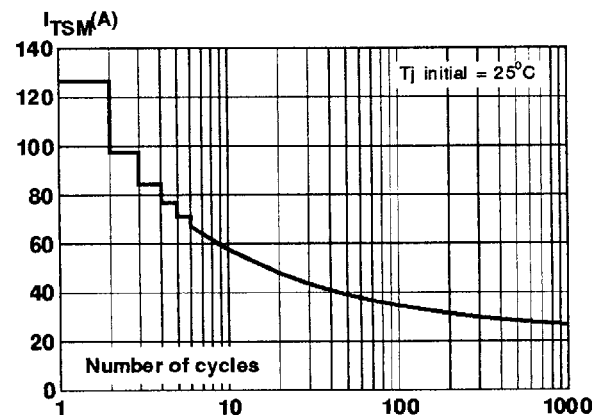
**Fig.4 :** Relative variation of thermal impedance versus pulse duration.



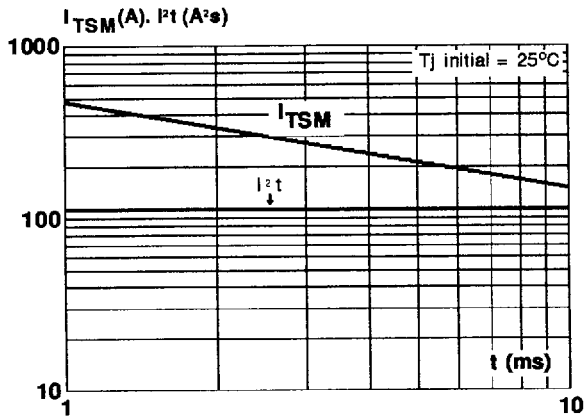
**Fig.5 :** Relative variation of gate trigger current and holding current versus junction temperature.



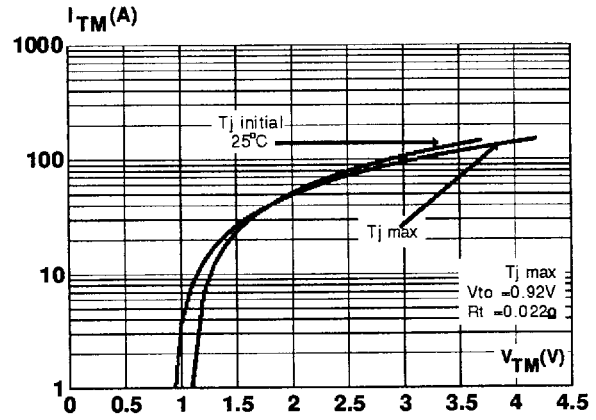
**Fig.6 :** Non repetitive surge peak on-state current versus number of cycles.



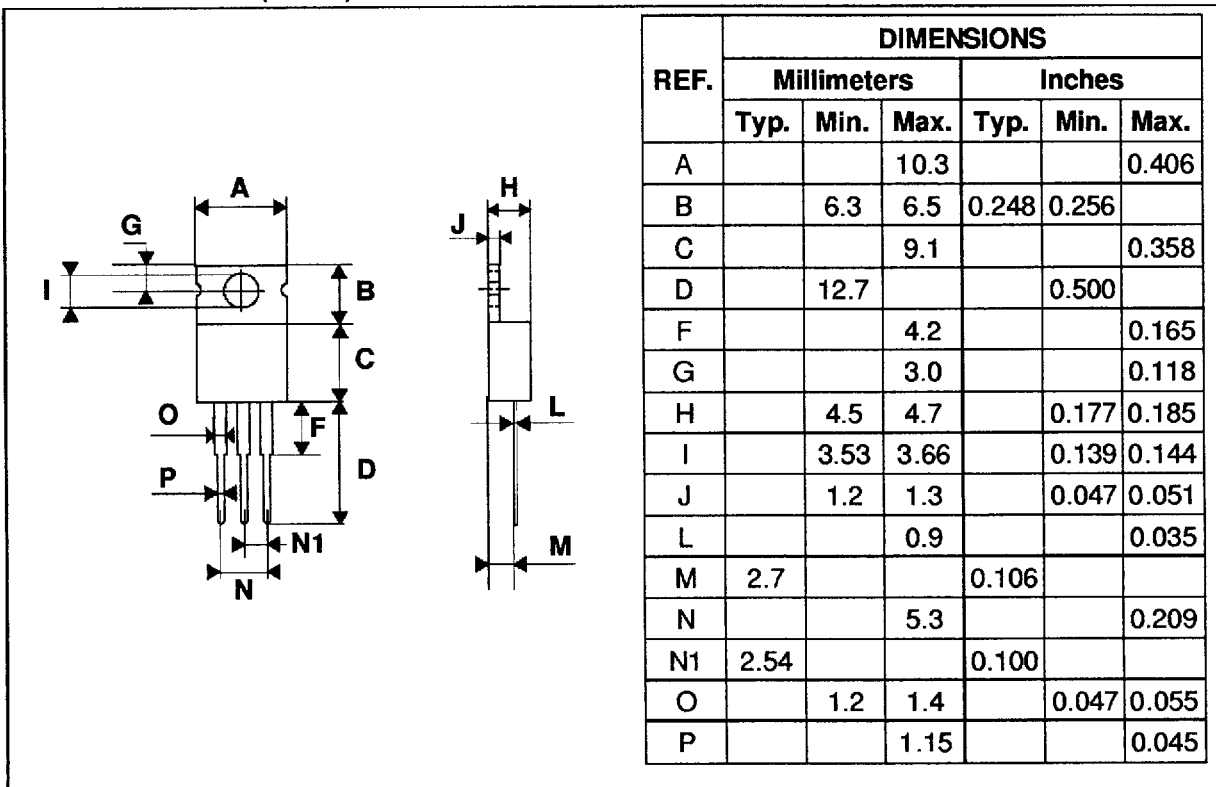
**Fig.7 :** Non repetitive surge peak on-state current for a sinusoidal pulse with width :  $t \leq 10\text{ms}$ , and corresponding value of  $I^2t$ .



**Fig.8 :** On-state characteristics (maximum values).



**PACKAGE MECHANICAL DATA**  
TO220 Non-insulated (Plastic)



Marking : type number  
Weight : 1.8g

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